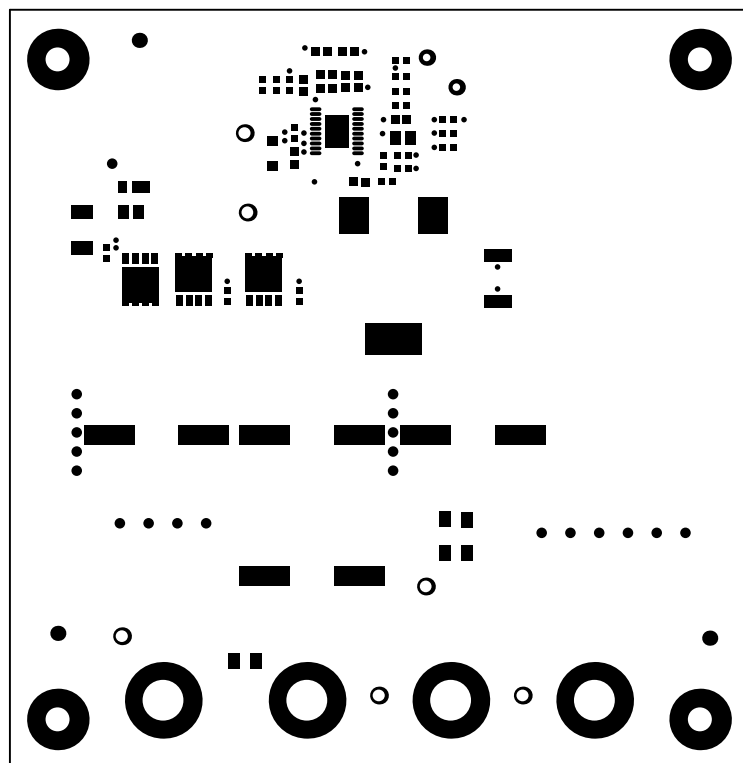
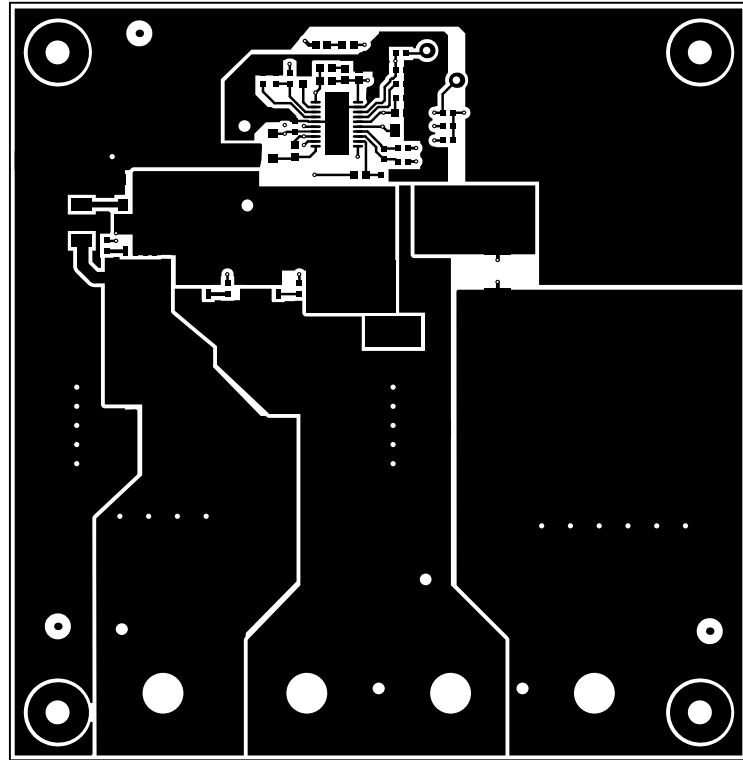


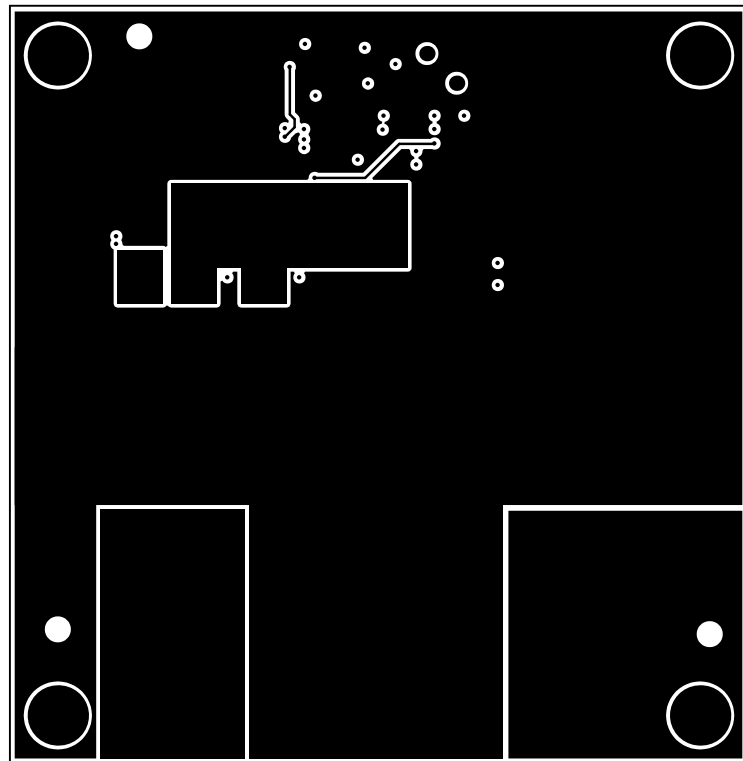
| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Overlay | | | |
| PLOT NAME = Top Overlay | GENERATED : 3/6/2013 8:47:41 AM | TEXAS INSTRUMENTS | |



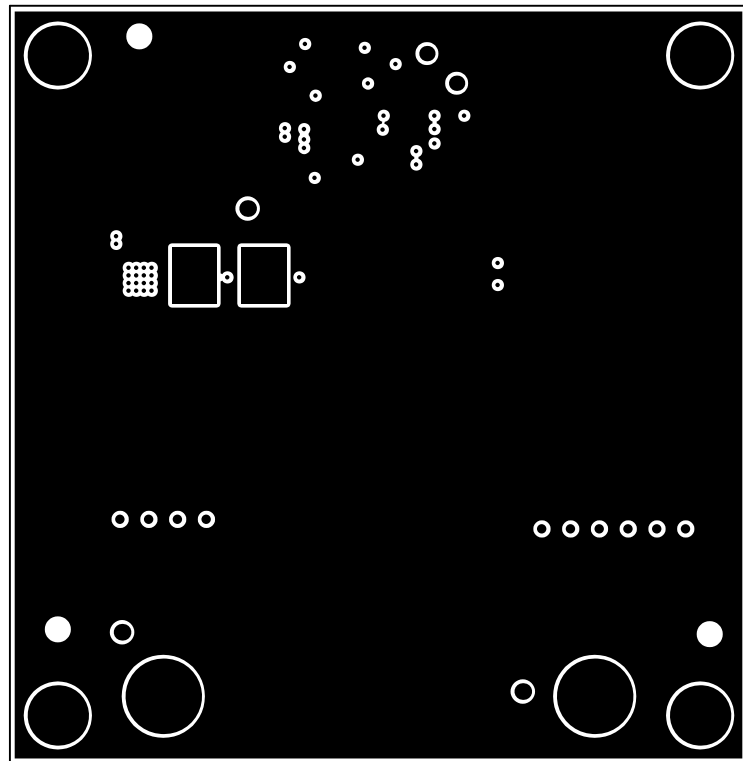
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| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Solder | | | |
| PLOT NAME = Top Solder Mask | GENERATED : 3/6/2013 8:47:41 AM | TEXAS INSTRUMENTS | |



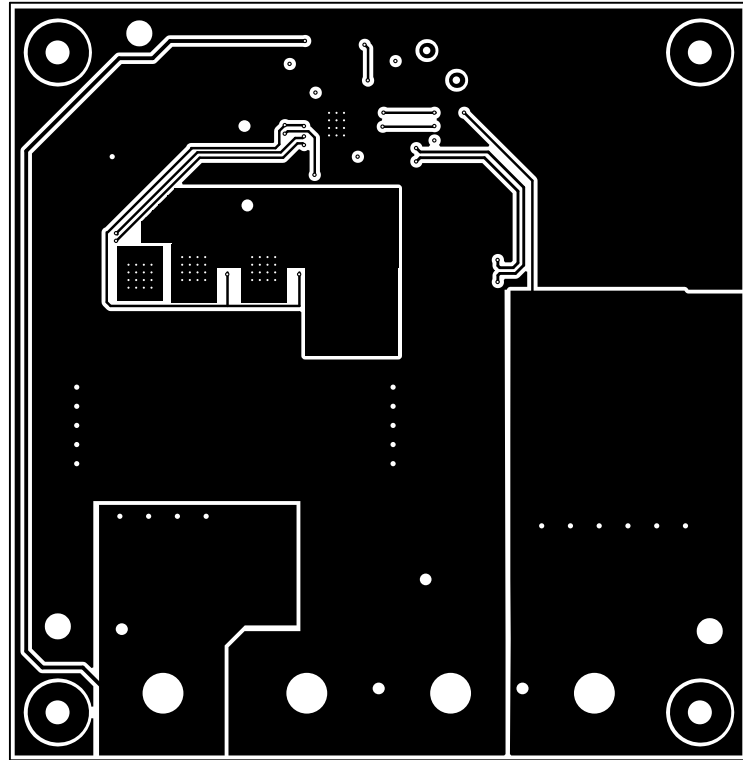
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|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Top Layer | | | |
| PLOT NAME = Top Layer | GENERATED : 3/6/2013 | 8:47:42 AM | TEXAS INSTRUMENTS |



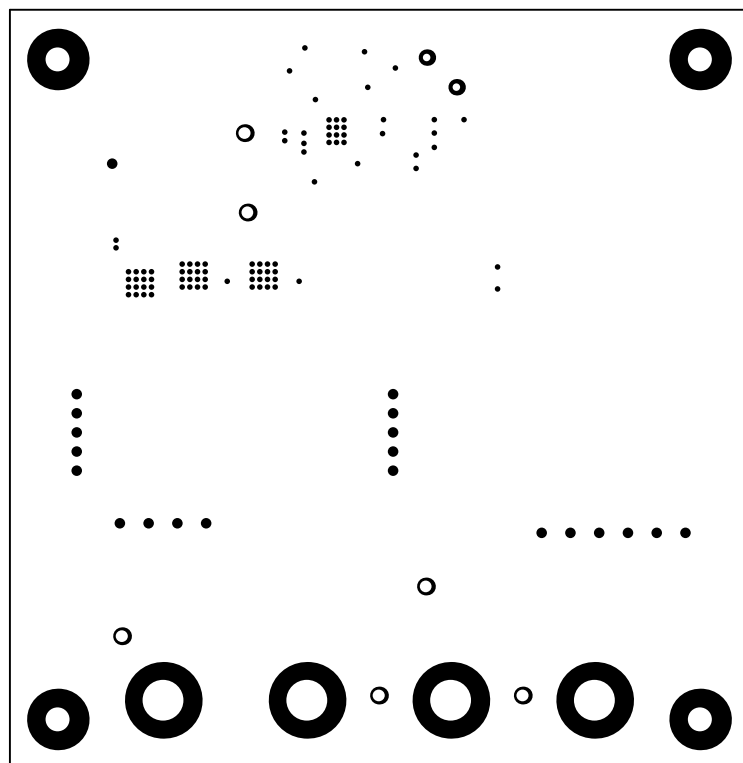
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| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = M1 Board Outline | | | |
| PLOT NAME = Mid Layer 1 | GENERATED : 3/6/2013 8:47:42 AM | TEXAS INSTRUMENTS | |



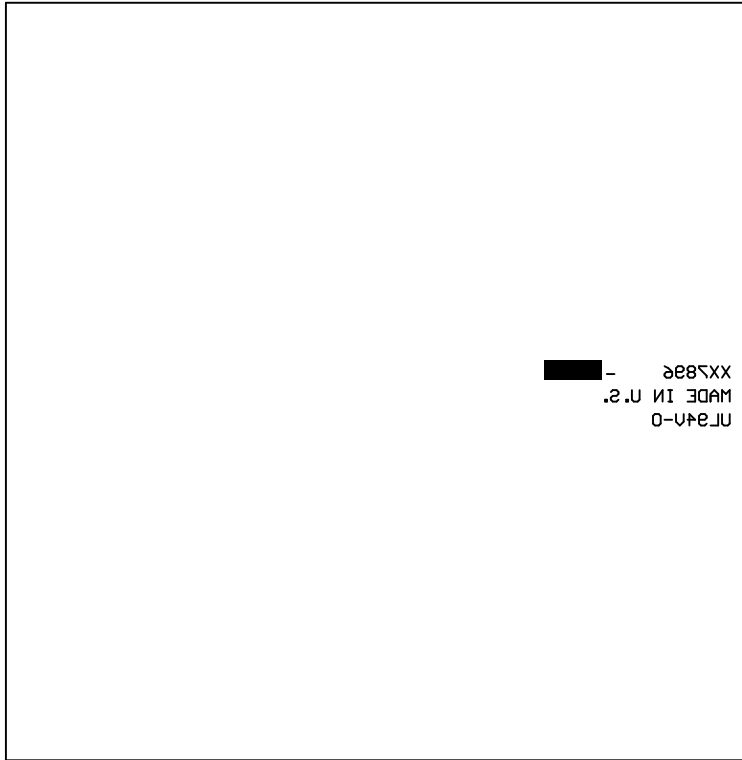
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| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = M1 Board Outline | | | |
| PLOT NAME = Mid Layer 2 | GENERATED : 3/6/2013 8:47:43 AM | TEXAS INSTRUMENTS | |



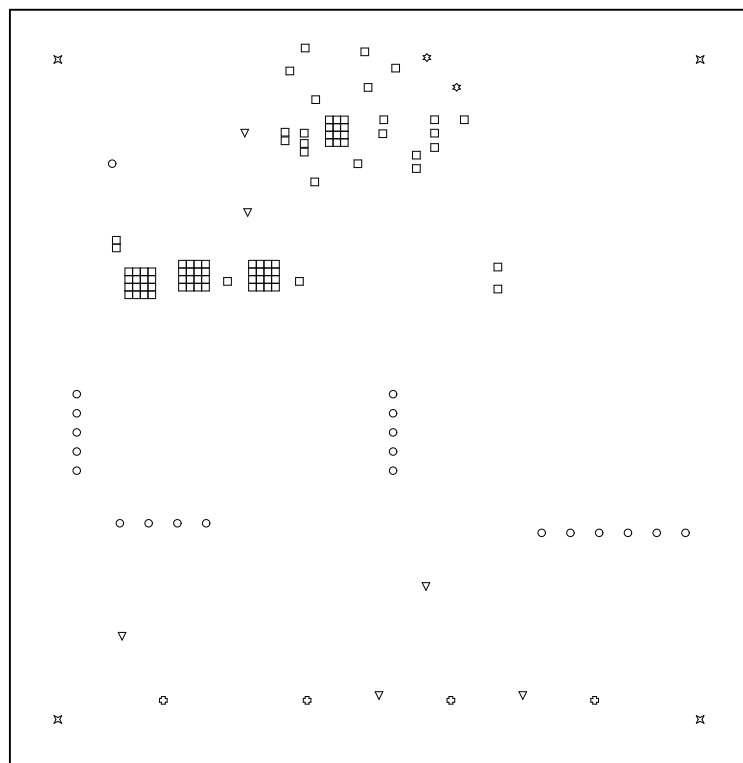
| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer | | | |
| PLOT NAME = Bottom Layer | GENERATED : 3/6/2013 8:47:43 AM | TEXAS INSTRUMENTS | |



| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Solder | | | |
| PLOT NAME = Bottom Solder Mask | GENERATED : 3/6/2013 8:47:44 AM | TEXAS INSTRUMENTS | |



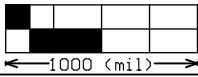
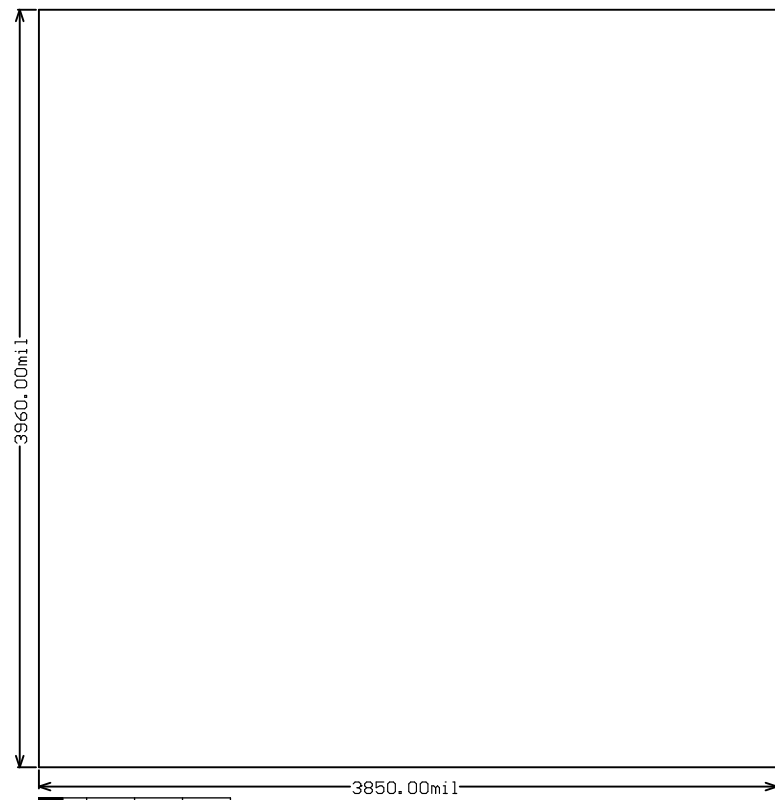
| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Bottom Overlay | | | |
| PLOT NAME = Bottom Overlay | GENERATED : 3/6/2013 8:47:44 AM | TEXAS INSTRUMENTS | |



| Symbol | Hit Count | Tool Size | Plated | Hole Type |
|-----------|-----------|---------------------|--------|-----------|
| □ | 87 | 12mil (0.305mm) | PTH | Round |
| ○ | 21 | 28mil (0.711mm) | PTH | Round |
| ☆ | 2 | 40mil (1.016mm) | PTH | Round |
| ▽ | 6 | 63mil (1.6mm) | PTH | Round |
| ✕ | 4 | 125.984mil (3.2mm) | PTH | Round |
| ⊙ | 4 | 214.567mil (5.45mm) | PTH | Round |
| 124 Total | | | | |

Drill Table

| | | | |
|----------------------------------|----------------------|------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = Drill Drawing | | | |
| PLOT NAME = Drill Drawing | GENERATED : 3/6/2013 | 8:47:44 AM | TEXAS INSTRUMENTS |



| | | | |
|----------------------------------|---------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: XX7896 | REV: E1 | SUN REV: Not In VersionControl |
| LAYER NAME = M2 Board Dimensions | | | |
| PLOT NAME = Board Dimensions | GENERATED : 3/6/2013 8:47:45 AM | TEXAS INSTRUMENTS | |

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